3.0A SCHOTTKY BARRIER RECTIFIER

Product Summary

B350BE/B350CE B360BE/B360CE

V _{RRM} (V)	I _O (A)	V _F Max (V) @ +25°C	I _R Max (mA) @ +25°C
50	3	0.65	0.1
60	3	0.65	0.2

Description and Applications

The Schottky rectifier providing low V_F and excellent reverse leakage stability at high temperatures, this device is ideal for use in general rectification applications such as:

- Boost Diode
- Blocking Diode
- Recirculating Diode

Features and Benefits

- Reduced Low Forward Voltage Drop (VF); Better Efficiency and Cooler Operation
- Reduced High-Temperature Reverse Leakage; Increased Reliability against Thermal Runaway Failure in High Temperature Operation
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: SMB, SMC
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Polarity: Cathode Band
- Weight: SMB- 0.093 grams (Approximate)
 SMC- 0.21 grams (Approximate)



Top View



Bottom View

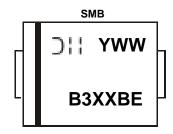
Ordering Information (Note 4)

Part Number	Case	Packaging
B3XXBE-13	SMB	3,000/Tape & Reel
B3XXCE-13	SMC	3,000/Tape & Reel

Notes:

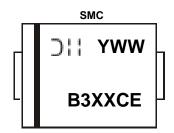
- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information





Marking Information (continued)



Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristic	Symbol	B350BE/B350CE	B360BE/B360CE	Unit
Peak Repetitive Reverse Voltage	VRRM			
Working Peak Reverse Voltage	VRWM	50	60	V
DC Blocking Voltage	V _{RM}	\vee /		
Average Rectified Output Current	lo	3		Α
Non-Repetitive Peak Forward Surge Current 8.3ms	IFSM	80		Δ
Single Half Sine-Wave Superimposed on Rated Load	IFSIM			73

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 5) SMB	Dou	90	°C/W
SMC	Reja	70	C/VV
Typical Thermal Resistance Junction to Case (Note 5) SMB	Dava	50	°C/W
SMC	Rejc	30	C/VV
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

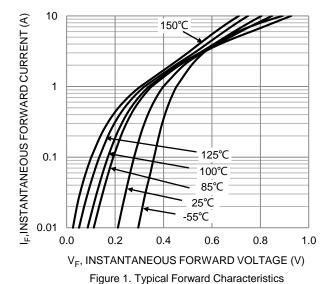
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
E. A. I.V. David	,,		0.55	0.65		I _F = 3A, T _J = +25°C
Forward Voltage Drop	VF	_	0.52	_	V	IF = 3A, T _J = +125°C
Leakage Current (Note 6) B350BE/ B350		_	_	0.1		V _R = 50V, T _J = +25°C
B360BE/ B360CE	IR	_	_	0.2	mA	$V_R = 60V, T_J = +25^{\circ}C$
			25	_		V _R = 60V, T _J = +125°C
Typical Capacitance	Ст	1	110	_	pF	$V_R = 4.0V, f = 1MHz$

Notes: 5. Device mounted on FR-4 substrate, 0.4"*0.5", 2oz, single-sided, PC boards with 0.2"*0.25" copper pad.

6. Short duration pulse test used to minimize self-heating effect.





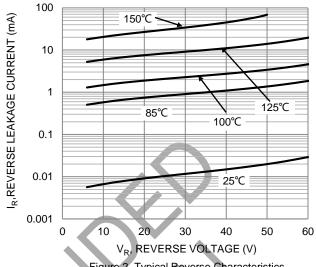
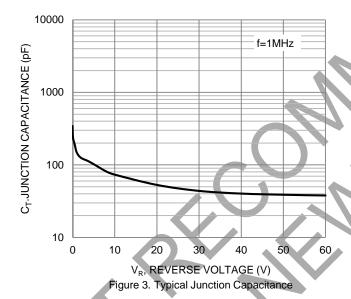
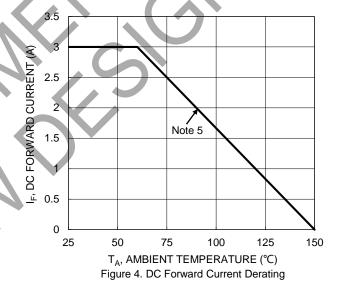


Figure 2. Typical Reverse Characteristics



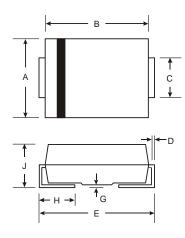




Package Outline Dimensions

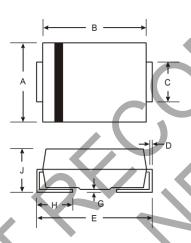
Please see http://www.diodes.com/package-outlines.html for the latest version.

SMB



SMB		
Dim	Min	Max
Α	3.30	3.94
В	4.06	4.57
C	1.96	2.21
D	0.15	0.31
Е	5.00	5.59
G	0.05	0.20
Н	0.76	1.52
7	2.00	2.50
All Dimensions in mm		

SMO



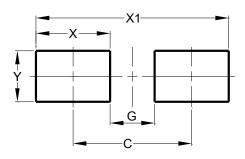
SMC				
Dim	Min	Max		
Α	5.59	6.22		
В	6.60	7.11		
C	2.75	3.18		
D	0.15	0.31		
Е	7.75	8.13		
G	0.10	0.20		
Н	0.76	1.52		
J	2.00	2.50		
All Dimensions in mm				



Suggested Pad Layout

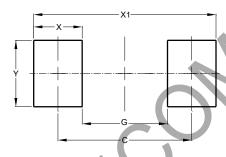
Please see http://www.diodes.com/package-outlines.html for the latest version.

SMB



Dimensions	Value (in mm)
С	4.30
G	1.80
Х	2.50
X1	6.80
Υ	2.30

SMC



Dimensions	Value (in mm)
С	6.90
G	4.40
X	2.50
X1	9.40
Υ	3.30



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